







Release Overview

<u> Highlights</u>



Always a step ahead ...

- Netlist extension
- NEW!
- YELO Copper Adjuster extensions
- YELO Legend Adjuster extensions
- YELO Mask Adjuster (Beta) extensions
- SEC file size reduction
- Ledia Output NEWI
- ODB++ Output optimization (NEW!)
- And more!

Netlist



Net number before remove connection

Extension

 Resource conserving update of net numbers of test-, mid- and probe-layers, corresponding to the newly calculated

netlist information

(Additions to existing Netlist license)



Pick Net 1

Pick Net 3 Pick Net 4 Pick Net 5

Different net numbers on test layers by only running netlist again

YELO Copper Adjuster

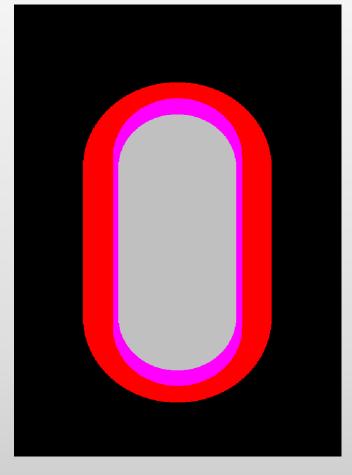


Extensions

- Ring faults for plated slots are reported and repaired
- Mechanical via holes can be expanded to fulfill the min. hole size requirement
- Plane adjustments optimizes bridge cuts into the contour to prevent unnecessary pads

(Additions to existing Copper Adjuster)

Ring faults for plated slots are reported and repaired



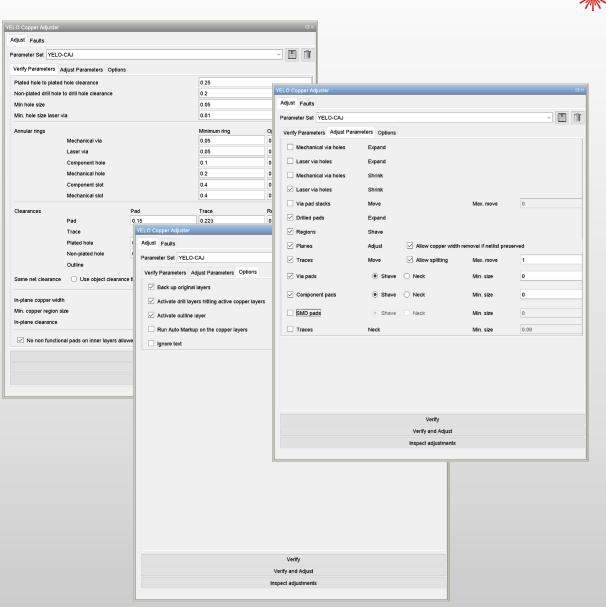
YELO Copper Adjuster



Extensions

- A new option to exclude text.
 All electrical nets that do not contain any pads are considered as text
- Improved GUI for better handling by using tab pages
- Updated ring parameters. 4 new adjustment parameters to check slots to a dedicated ring parameter

(Additions to existing Copper Adjuster)



YELO Legend Adjuster

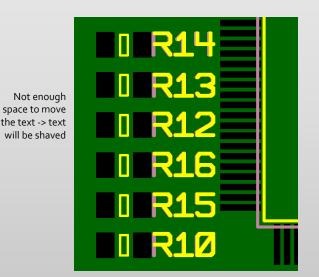


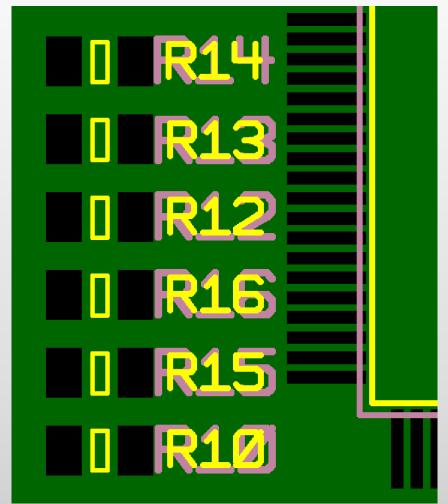
No shave necessary after scaling text

Extensions

 The Adjust tab contains a new option to scale all texts in one go on all active layers by a certain factor.
 It always preserves the minimum line width.

(Additions to existing Legend Adjuster)





Secure Etch Compensation



File size reduction

- Boost the speed of file handling with the new option to reduce object count for clearance draws by replacing chains of draws
- A new 'Finalize' option and a check box 'Auto Finalize' have been added to the SEC GUI to prevent negative objects
 - 'Finalize' to run netlist and expand true objects on active layers manually
 - Checked 'Auto Finalize' will run automatically at the end of 'Apply' to eliminate the negative clearance draws

(Additions to existing SEC)

Change of file size (same data same values)

Before changes:

11.182 MB

With Finalize:

7,235 MB

With replacing chains of draws:

1.616 MB

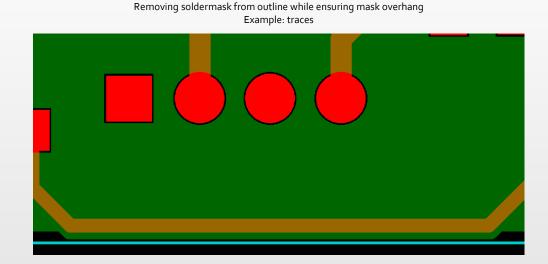
YELO Mask Adjuster (Beta)

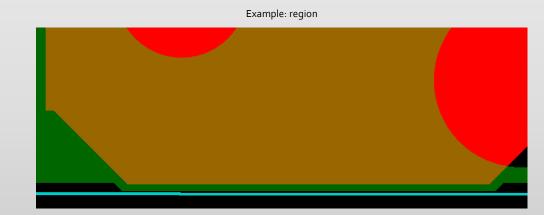


Extensions

- Due to the great feedback in the first trial period, the trial is extended for this release
- Added option to remove existing mask openings for vias
- Clearance to outline and overhang implemented

(Available to customers under maintenance and with the existing Soldermask Optimizer license)





YELO Mask Adjuster (Beta)

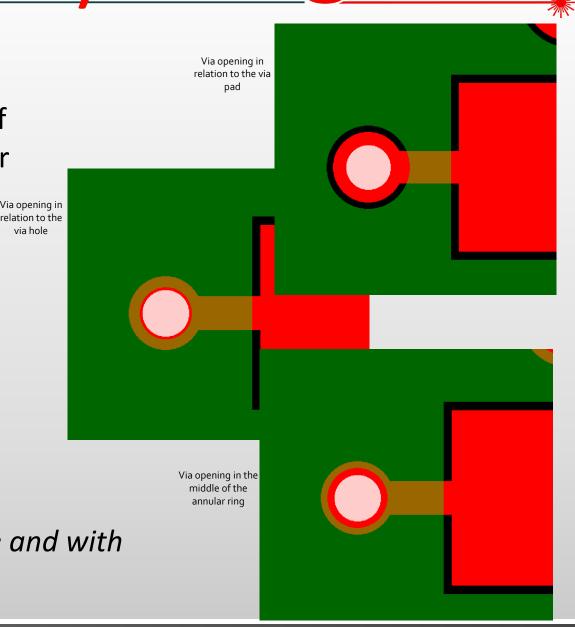
Extensions

 Expanded functionality for adjustment of via openings to the middle of the annular ring between hole and copper pad Via opening in

 Outline handling of cut-outs and inner rout implemented

 Rings for non-plated slots were added to Mask Adjuster. It handles these the same way as non-plated holes

(Available to customers under maintenance and with the existing Soldermask Optimizer license)



via hole

Ledia Output

Ucamco **

New Hotfolder solution

- Be able to send data to expose on the Ledia machine without taking care of the CU9000 software version
- UcamX is completely independent of CU9000, it is not sending data directly to the Ledia RIP but is always sending data to CU9000 via hotfolder

(New option, available free of charge to customers under maintenance with the existing "Dainippon Screen DI Output" license)

SCREEN LI Output ×							
Group	√ ™ ⊾						
Job	DI Testdata						
Front Layer	Top Load						
Front Layer Name	Тор						
Back Layer	Bot Change						
Back Layer Name	Bot						
Machine	ledia (Ledia5S_365_385_405)						
Board Setup File	C:\SS\DS_DI_ROOT\brd\221181.brd						
Resist Setup File							
Board Setup Resist Setup Text Setup Local Align. Setup							
Board Setup		Load			Save		
Size	458			615			
Thickness	0.15						
Mirror	None						
Rotation	0 ~						
Polarity	Positive						
Alignment Center	Job Layer CAD					D	
Offset	-0.5			1.5			
Alignment Points	3 Marks	3 Marks			Detect		
Image File	hole_2mi	hole_2mm					
AP1 F	454.498	454.498			259.499		
AP2 P	2.498	2.498			114.499		
AP3 F	2.498			495.499	195.499		
AP4	0	0					
	● CAD		OBoard		O Machine		
		Hide Glo	bal Alignmer	nt		٠	
Back Layer Mirror	Υ					~	
Conversion Mag.	1.0003		times	1.00045		times	
Plot Mag.	1.0		times	1.0		times	
Group Scaling					Browse	Edit	
		Max			Min		
Scaling Tol. X	0.0		%	0.0		%	
Scaling Tol. Y							
Hide Output Options							
✓ Apply to front layers							
✓ Apply to back layers							
Keep layer orde	er						
Preview Apply XML Output							

ODB++ Output



Optimization

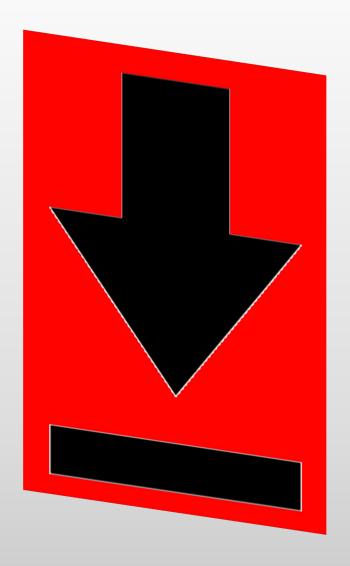
 ODB++ output is correctly handling the scale factor allocated to a block aperture definition. This scale factor was previously ignored during ODB++ output

(Addition to existing CAD Output ODB++)

Install v2021.04



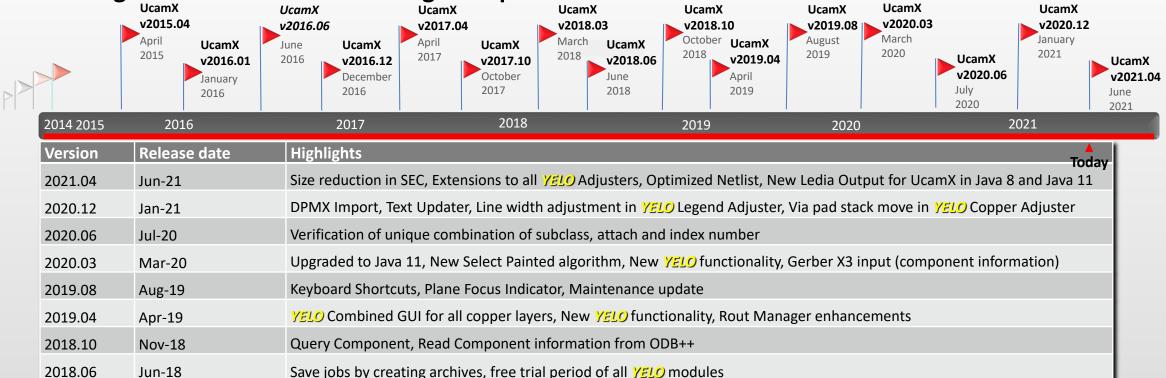
- The installer can be downloaded from the Ucamco FTP download server. As most internet browsers have stopped supporting FTP download, we recommend that you use an FTP client to do so
- We recommend installing this update at your earliest convenience
- For any further questions you may have, please contact our local business partner or the Ucamco helpdesk
- We thank you for choosing a Ucamco product



Already looking ahead



Serving our customer base with regular updates



New startup routine, Extended Job Editor View, Optimized Rout Compensation

Performance boost DRC copper-cut-ins, Improved "Select Painted" feature

New insert Arc command, Improved Sieb&Meyer rout import

Eagle input with proportional font, Scaled line width in Silk optimizer, Introduction of YELO Signal Layer Adjuster

		, ,
2016.06	Jun-16	Maintenance update
2016.01	Jan-16	Background output, Parallelized image compare
2015.04	Apr-15	Load balanced sessions, Gerber X2 Input support

2018.03

2017.10

2017.04

2016.12

Mar-18

Oct-17

Apr-17

Dec-16

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